

## C1812X474K5RACTU

Aliases (C1812X474K5RAC7800) SMD Comm X7R Flex, Ceramic, 0.47 uF, 10%, 50 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1812, 2.3 mm



General Information		
Series	SMD Comm X7R Flex	
Style	SMD Chip	
Description	SMD, MLCC, FT-CAP, Temperature Stable	
Features	FT-CAP, Temperature Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
AEC-Q200	No	
Typical Component Weight	95 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions		
Chip Size	1812	
L	4.5mm +/-0.4mm	
W	3.2mm +/-0.3mm	
Т	1mm +/-0.10mm	
S	2.3mm MIN	
В	0.7mm +/-0.35mm	

V V	3.2mm ·/ -0.3mm	
Т	1mm +/-0.10mm	
S	2.3mm MIN	
В	0.7mm +/-0.35mm	
Packaging Specifications		

Packaging

Specifications		
Capacitance	0.47 uF	
Measurement Condition	1 kHz 1.0Vrms	
Tolerance	10%	
Voltage DC	50 VDC	
Dielectric Withstanding Voltage	125 VDC	
Temperature Range	-55/+125°C	
Temp. Coefficient	X7R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms	
Dissipation Factor	2.5% 1 kHz 1.0 Vrms	
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	2.1277 GOhms	

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Packaging Quantity	1000	Dissipation Factor	2.5%1kH
		Aging Rate	3% Loss,

T&R 180mm Plastic Tane

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